

Multilayer Ceramic Chip Capacitors

C2012CH2A103K125AA



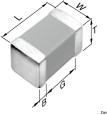






TDK item description C2012CH2A103KT****

Applications	Commercial Grade	
Feature	Mid Voltage (100 to 630V)	
Series	C2012 [EIA 0805]	
Status	Production (Not Recommended for New Design)	



imensions	in	mm	

	Size
Length(L)	2.00mm ±0.20mm
Width(W)	1.25mm ±0.20mm
Thickness(T)	1.25mm ±0.20mm
Terminal Width(B)	0.20mm Min.
Terminal Spacing(G)	
Recommended Land Pattern (PA)	1.00mm to 1.30mm(Flow Soldering)
recommended Land Fattern (FA)	0.90mm to 1.20mm(Reflow Soldering)
Recommended Land Pattern (PB)	1.00mm to 1.20mm(Flow Soldering)
Recommended Land Fattern (FB)	0.70mm to 0.90mm(Reflow Soldering)
Recommended Land Pattern (PC)	0.80mm to 1.10mm(Flow Soldering)
neconfinenced Land Fattern (FC)	0.90mm to 1.20mm(Reflow Soldering)

Electrical Characteristics		
Capacitance	10nF ±10%	
Rated Voltage	100VDC	
Temperature Characteristic	CH(0±60ppm/°C)	
Q (Min.)	1000	
Insulation Resistance (Min.)	10000ΜΩ	

Other	
Caldarina Mathad	Wave (Flow)
Soldering Method	Reflow
AEC-Q200	No
Packing	Blister (Plastic)Taping [180mm Reel]
Package Quantity	2000pcs

[!] Images are for reference only and show exemplary products.

[!] This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.

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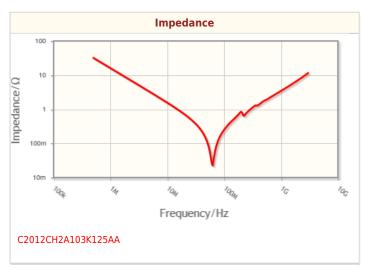


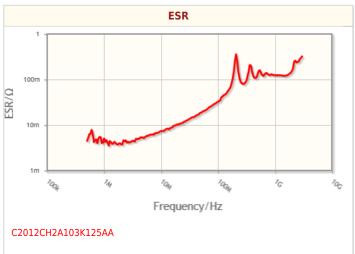


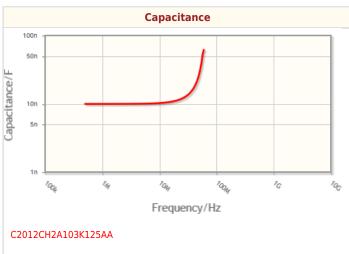


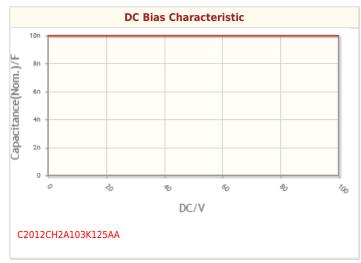


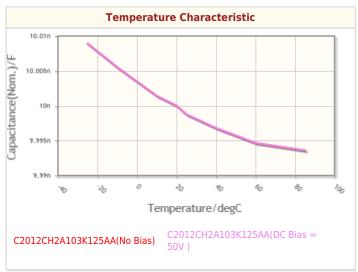
Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)











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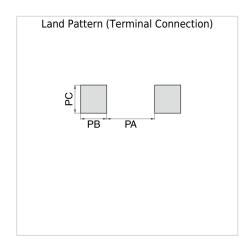








Associated Images



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